

SURFACE MOUNT HIGH SPEED SILICON SWITCHING DIODE





www.centralsemi.com

DESCRIPTION:

The CENTRAL SEMICONDUCTOR CLL4448 type is a ultra-high speed silicon switching diode manufactured by the epitaxial planar process, in a hermetically sealed glass surface mount package, designed for high speed switching applications.

MARKING: CATHODE BAND

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Continuous Reverse Voltage	V _R	75	V
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Continuous Forward Current	۱ _F	250	mA
Peak Repetitive Forward Current	I _{FRM}	500	mA
Peak Forward Surge Current, tp=1.0µs	I _{FSM}	4.0	А
Peak Forward Surge Current, tp=1.0s	I _{FSM}	1.0	А
Power Dissipation	PD	500	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +200	°C
Thermal Resistance	Θ_{JA}	350	°C/W

ELECTRICAL CHARACTERISTICS: (T_A=25°C unless otherwise noted)

TEST CONDITIONS	MIN	MAX	UNITS
V _R =20V		25	nA
I _R =5.0μΑ	75		V
Ι _R =100μΑ	100		V
I _F =5.0mA	0.62	0.72	V
I _F =100mA		1.0	V
V _R =0, f=1.0 MHz		4.0	pF
$I_R=I_F=10$ mA, R _L =100 Ω , Rec. to 1.0mA		4.0	ns
	$V_{R}=20V$ $I_{R}=5.0\mu A$ $I_{R}=100\mu A$ $I_{F}=5.0m A$ $I_{F}=100m A$ $V_{R}=0, f=1.0 MHz$	$V_{R}=20V$ $I_{R}=5.0\mu A$ $I_{R}=100\mu A$ $I_{F}=5.0m A$ $I_{F}=100m A$ $V_{R}=0, f=1.0 \text{ MHz}$ $T=100 \text{ MHz}$	$\begin{array}{ccc} V_{R} = 20V & & 25\\ I_{R} = 5.0\muA & & 75\\ I_{R} = 100\muA & & 100\\ I_{F} = 5.0mA & & 0.62 & 0.72\\ I_{F} = 100mA & & 1.0\\ V_{R} = 0, \ f = 1.0 \ MHz & & 4.0 \end{array}$

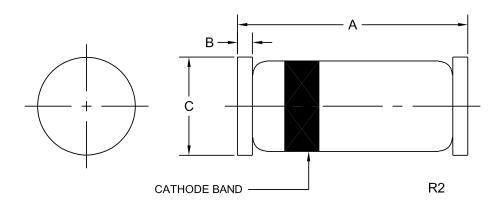
R4 (8-January 2010)





SURFACE MOUNT HIGH SPEED SILICON SWITCHING DIODE

SOD-80 CASE - MECHANICAL OUTLINE



MARKING: CATHODE BAND

DIMENSIONS							
	INCHES		MILLIMETERS				
SYMBOL	MIN	MAX	MIN	MAX			
Α	0.130	0.146	3.30	3.71			
В	0.014		0.35				
C (DIA)	0.049	0.067	1.25	1.70			
SOD-80 (REV:R2)							

R4 (8-January 2010)

www.centralsemi.com

OUTSTANDING SUPPORT AND SUPERIOR SERVICES

PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- Inventory bonding
- · Consolidated shipping options

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free quick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- Custom electrical curves
- Environmental regulation compliance
- Customer specific screening
- Up-screening capabilities

ss your design challenges.

· Custom product packing

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits

Custom bar coding for shipments

Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA Main Tel: (631) 435-1110 Main Fax: (631) 435-1824 Support Team Fax: (631) 435-3388 www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

Worldwide Distributors: www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: <u>www.centralsemi.com/terms</u>

